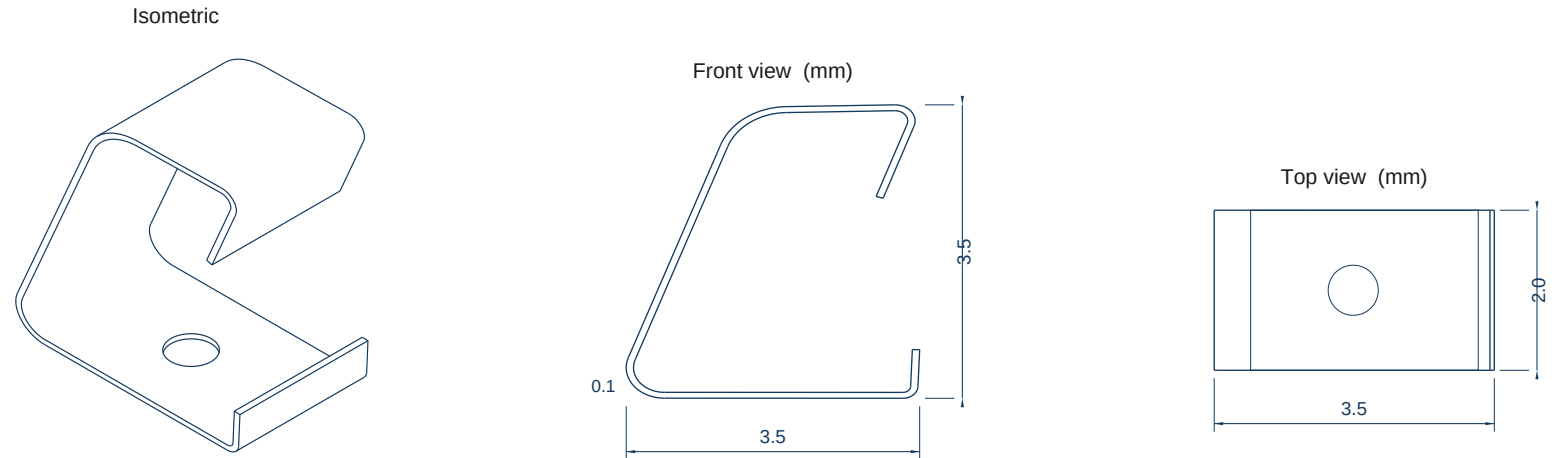




Type C-05 BC05-20035035

SMD EMI Spring Contact | Beryllium Copper | Units: mm



MECHANICAL	VALUE
Thickness	0.10 mm
Width	2.0 mm +/- 0.2
Length	3.5 mm +/- 0.2
Height	3.5 mm +/- 0.2
Form	C-section: base, back wall, top arm, tail (no base flange)
Profile source	scaled from BC05-25040050, x0.875 (L) / x0.700 (H) - see note
Base hole	dia 0.63 mm at 1.74 from end (scaled)
Material / plating	BeCu, Gold-plated (G)
Volume / mass	1.594 mm ³ 13.3 mg (BeCu)
File format	STEP AP214

PRODUCT DATA	VALUE
Mfr P/N	BC05-20035035G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 3.5x2.0x3.5mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-c-05.html